

Reference-Name : BD16950EFV-EVK-001

PCB Layer structure	PCB層構造(Japanese)	File Name
TOP Silkscreen	Top Silk	BD16950EFV-EVK-001 -Top_Silk.gto
Top Resist	Top Resist	BD16950EFV-EVK-001 -Top_Mask.gts
Top Layer	Top Metal (M1)	BD16950EFV-EVK-001 -Top_Layer.gtl
Bottom Layer	Bottom Metal (M4)	BD16950EFV-EVK-001 -Bottom_Layer.gbl
Bottom Resist	Bottom Resist	BD16950EFV-EVK-001 -Bottom_Mask.gbs
Bottom Silkscreen	Bottom Silk	BD16950EFV-EVK-001 -Bottom_Silk.gbo
PCB Out-line	基板外形	BD16950EFV-EVK-001 -Outline.gko
Plated Through Hole	メッキ穴	BD16950EFV-EVK-001 -Drill_PTH.drl
Non-Plated Through Hole	メッキ無穴	BD16950EFV-EVK-001 -Drill_NPTH.drl
Plated Through Hole Map	メッキ穴位置	BD16950EFV-EVK-001 -Drill_PTH-drl_map.ps
Non-Plated Through Hole Map	メッキ無穴位置	BD16950EFV-EVK-001 -Drill_NPTH-drl_map.ps